

Linear Systems Monolithic Dual PNP Transistor

The LS350 is a monolithic pair of PNP transistors mounted in a single SOIC package. The monolithic dual chip design reduces parasitics and gives better performance while ensuring extremely tight matching.

The 8 Pin SOIC provides ease of manufacturing, and the symmetrical pinout prevents improper orientation.

(See Packaging Information).

- Very high gain
- Tight matching
- Low Output Capacitance

FEATURES

HIGH GAIN	$h_{FE} \geq 100$ @ 10 μ A-1mA
TIGHT V_{BE} MATCHING	$ V_{BE1} - V_{BE2} = 0.1\text{mV TYP.}$
HIGH f_t	275MHz TYP. @ 1mA

ABSOLUTE MAXIMUM RATINGS¹
@ 25°C (unless otherwise noted)

Maximum Temperatures

Storage Temperature	-65°C to +200°C
Operating Junction Temperature	-55°C to +150°C

Maximum Power Dissipation

Continuous Power Dissipation (One side)	250mW
Continuous Power Dissipation (Both sides)	500mW
Linear Derating factor (One side)	2.3mW/°C
Linear Derating factor (Both sides)	4.3mW/°C

Maximum Currents

Collector Current	10mA
-------------------	------

MATCHING CHARACTERISTICS @ 25°C (unless otherwise stated)

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	CONDITIONS
$ V_{BE1} - V_{BE2} $	Base Emitter Voltage Differential	--	1	5	mV	$I_C = 10\mu\text{A}, V_{CE} = 5\text{V}$
$\Delta (V_{BE1} - V_{BE2}) / \Delta T$	Base Emitter Voltage Differential Change with Temperature	--	2	20	$\mu\text{V}/^\circ\text{C}$	$I_C = 10\mu\text{A}, V_{CE} = 5\text{V}$ $T_A = -55^\circ\text{C to } +125^\circ\text{C}$
$ I_{B1} - I_{B2} $	Base Current Differential	--	--	--	nA	$I_C = 10\mu\text{A}, V_{CE} = 5\text{V}$
$ \Delta (I_{B1} - I_{B2}) / ^\circ\text{C}$	Base Current Differential Change with Temperature	--	--	--	$\text{nA}/^\circ\text{C}$	$I_C = 10\mu\text{A}, V_{CE} = 5\text{V}$ $T_A = -55^\circ\text{C to } +125^\circ\text{C}$
h_{FE1} / h_{FE2}	DC Current Gain Differential	--	10	--	%	$I_C = 10\mu\text{A}, V_{CE} = 5\text{V}$

ELECTRICAL CHARACTERISTICS @ 25°C (unless otherwise noted)

SYMBOL	CHARACTERISTICS	MIN.	TYP.	MAX.	UNITS	CONDITIONS
BV_{CBO}	Collector to Base Voltage	25	--	--	V	$I_C = 10\mu\text{A}, I_E = 0$
BV_{CEO}	Collector to Emitter Voltage	25	--	--	V	$I_C = 10\mu\text{A}, I_B = 0$
BV_{EBO}	Emitter-Base Breakdown Voltage	6.2	--	--	V	$I_E = 10\mu\text{A}, I_C = 0^2$
BV_{CCO}	Collector to Collector Voltage	30	--	--	V	$I_C = 10\mu\text{A}, I_E = 0$
h_{FE}	DC Current Gain	100	--	--		$I_C = 10\mu\text{A}, V_{CE} = 5\text{V}$
		100	--	--		$I_C = 100\mu\text{A}, V_{CE} = 5\text{V}$
		100	--	--		$I_C = 1\text{mA}, V_{CE} = 5\text{V}$
$V_{CE(SAT)}$	Collector Saturation Voltage	--	--	0.5	V	$I_C = 1\text{mA}, I_B = 0.1\text{mA}$
I_{EBO}	Emitter Cutoff Current	--	--	0.2	nA	$I_E = 0, V_{CB} = 3\text{V}$
I_{CBO}	Collector Cutoff Current	--	--	0.2	nA	$I_E = 0, V_{CB} = 20\text{V}$
C_{OBO}	Output Capacitance	--	--	2	pF	$I_E = 0, V_{CB} = 5\text{V}$
C_{C1C2}	Collector to Collector Capacitance	--	--	2	pF	$V_{CC} = 0\text{V}$
I_{C1C2}	Collector to Collector Leakage Current	--	--	0.5	nA	$V_{CC} = \pm 45\text{V}$
f_T	Current Gain Bandwidth Product	200	--	--	MHz	$I_C = 1\text{mA}, V_{CE} = 5\text{V}$
NF	Narrow Band Noise Figure	--	--	3	dB	$I_C = 100\mu\text{A}, V_{CE} = 5\text{V}, BW = 200\text{Hz}, R_G = 10\text{K}\Omega, f = 1\text{KHz}$

Notes:

1. Absolute Maximum ratings are limiting values above which serviceability may be impaired
2. The reverse base-to-emitter voltage must never exceed 6.2 volts; the reverse base-to-emitter current must never exceed 10 μ A.

Available Packages:

LS350 in SOIC
LS350 available as bare die

Please contact Micross for full package and die dimensions:

Email: chipcomponents@micross.com
Web: www.micross.com/distribution.aspx

Information furnished by Linear Integrated Systems and Micross Components is believed to be accurate and reliable. However, no responsibility is assumed for its use; nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Linear Integrated Systems.

SOIC (Top View)

